UNITED STATES SECURITIES AND EXCHANGE COMMISSION

Washington, D.C. 20549

Form 6-K

REPORT OF FOREIGN PRIVATE ISSUER PURSUANT TO RULE 13a-16 OR 15d-16 UNDER THE SECURITIES EXCHANGE ACT OF 1934

For the month of December, 2018

Commission File Number: 001-31994

Semiconductor Manufacturing International Corporation

(Translation of registrant's name into English)

18 Zhangjiang Road Pudong New Area, Shanghai 201203 People's Republic of China (Address of principal executive office)

Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F:

⊠ Form 20-F □ Form 40-F

Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(1):

Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(7): \Box

Indicate by check mark whether the registrant by furnishing the information contained in this Form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934:

🗆 Yes 🛛 No

If "Yes" is marked, indicate below the file number assigned to the registrant in connection with Rule 12g3-2(b): n/a

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Semiconductor Manufacturing International Corporation

Date: December 11, 2018

By: /s/ Dr. Gao Yonggang

Name: Dr. Gao Yonggang Title: Executive Director, Chief Financial Officer and Joint Company Secretary Hong Kong Exchanges and Clearing Limited and The Stock Exchange of Hong Kong Limited take no responsibility for the contents of this announcement, make no representation as to its accuracy or completeness and expressly disclaim any liability whatsoever for any loss howsoever arising from or in reliance upon the whole or any part of the contents of this announcement.



SEMICONDUCTOR MANUFACTURING INTERNATIONAL CORPORATION 中芯國際集成電路製造有限公司*

(incorporated in the Cayman Islands with limited liability) (Stock Code: 981)

DELAY IN DESPATCH OF CIRCULAR

Reference is made to the announcement of the Company dated 29 November 2018 (the "**Announcement**") regarding to continuing connected transactions in relation to centralised fund management agreement. Capitalised terms used in this announcement shall have the same meanings as defined in the Announcement unless otherwise defined herein.

Pursuant to Rule 14A.47 and Rule 14A.68 (11) of the Listing Rules, a circular (the "**Circular**") should be Dispatched to the Shareholders. The Circular will contain, among other things, (i) further details of the Framework Agreement; (ii) a letter from the Independent Board Committee to the Independent Shareholders; (iii) a letter from the Independent Financial Adviser to the Independent Board Committee and the Independent Shareholders; and (iv) a notice convening the EGM.

As additional time is required to finalise the information to be contained in the circular, the despatch of the circular will be delayed and the Company expects to despatch the circular on or before 28 December 2018.

By order of the Board Semiconductor Manufacturing International Corporation Gao Yonggang Executive Director, Chief Financial Officer and Joint Company Secretary

Shanghai, PRC 11 December 2018 As at the date of this announcement, the directors of the Company are:

Executive Directors

ZHOU Zixue (Chairman)LIANG Mong Song (Co-Chief Executive Officer)ZHAO Haijun (Co-Chief Executive Officer)GAO Yonggang (Chief Financial Officer and Joint Company Secretary)

Non-executive Directors

CHEN Shanzhi ZHOU Jie REN Kai LU Jun TONG Guohua

Independent Non-executive Directors

William Tudor BROWN CHIANG Shang-yi CONG Jingsheng Jason LAU Lawrence Juen-Yee FAN Ren Da Anthony

* For identification purposes only